

Validating C2M VEC and VEO Limits

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April 21, 2021

Overview

❑ Updated analysis is with COM 3.1.0

- The updated TP1a analysis uses [lim_3ck_adhoc_02_073119](#) channels
- The updated TP4 analysis uses [lim_3ck_02_0719](#) channels

❑ COM analysis investigates impact of $t_s = \pm 50$ mUI rectangular window on established VEO/VEC limits of D1.3 draft

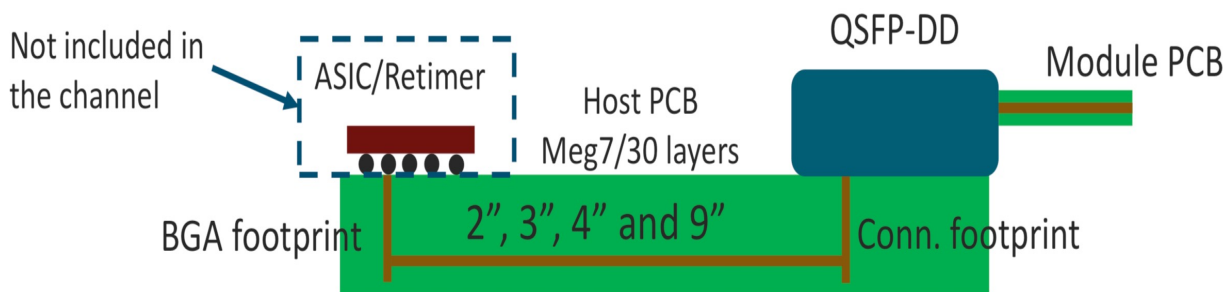
- The intention was to only adjust the TP1a/TP4 limits due to $t_s = \pm 50$ mUI rectangular window
- But D2.0 VEO/VEC limits at TP1a have been tighten compare to D1.3 without rectangular window for the host and relaxed for the module
- Tightening the VEO/VEC limits results in some of Lim TP1a channels failing that previously passed

❑ Addressing D2.0 comments 34, 41, 42, 46, and 48.

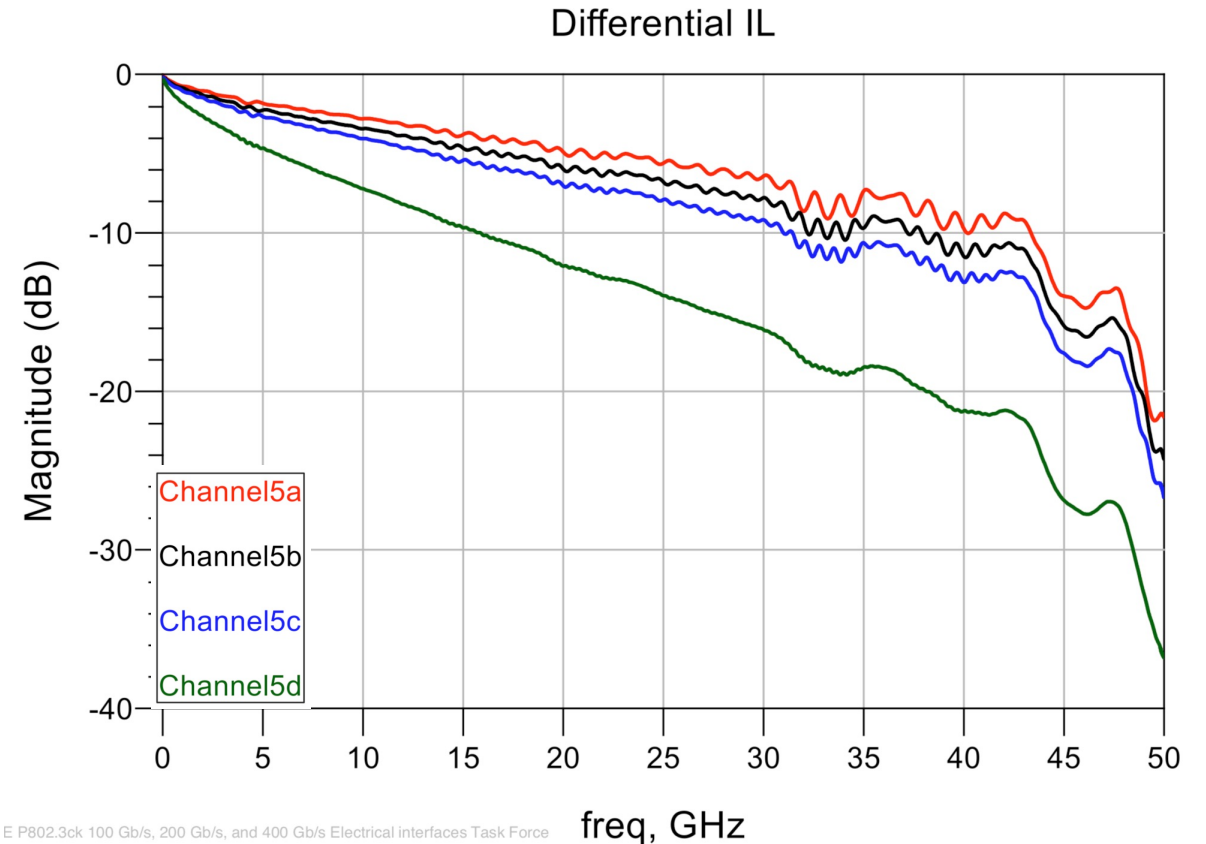
C2M TP1a Channels for Updated Analysis

□ Channel based on [lim_3ck_adhoc_02_073119](#) as shown

- 16 pairs (8 Tx, 8 Rx) QSFP-DD SMT Connector with host PCB footprint
- PCB stackup is 30 layers, 150 mils thick, based on Meg7 material
- PCB via stub length is modeled as 10 mils
- Diff pair trace width/spacing is 4.5 mils /8.5 mils
- ASIC and retimer footprint are simulated with actual BGA ball-out using the same PCB stackup.



□ This analysis uses min loss channel 5a and max loss channel 5d.

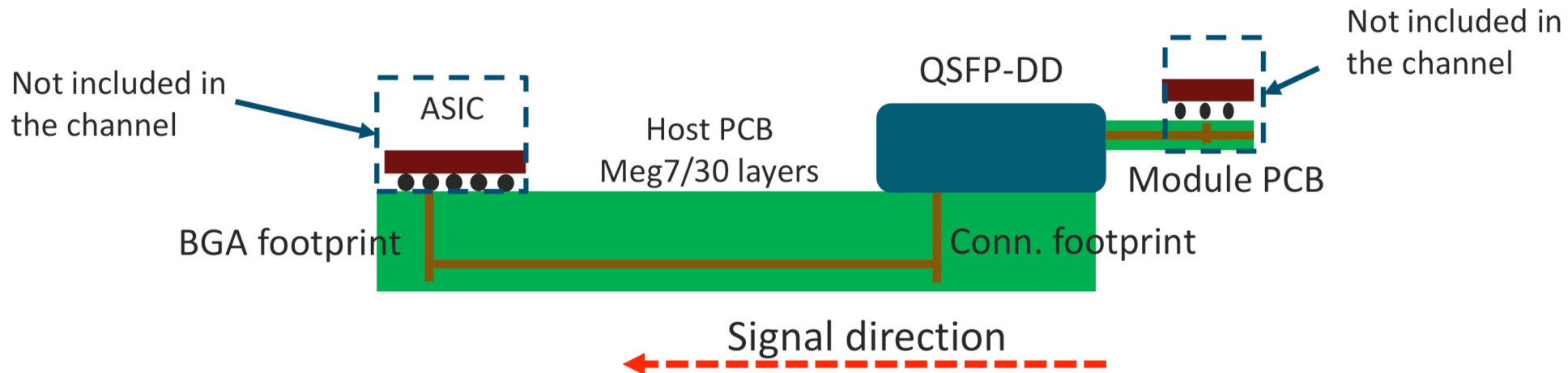


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C2M TP4 Channels for Updated Analysis

□ Channel based on [lim_3ck_02_0719](#) shown

- 16 pairs (8 Tx, 8 Rx) QSFP-DD SMT Connector and host PCB footprint are solved as one piece in HFSS
- PCB stackup is 30 layers, 150mil thick, with Meg7 material
- PCB via stub length is modelled as 10mil
- Diff pair trace width/spacing is 4.5mil/8.5mil, 2 different trace lengths are used (2" & 9")
- ASIC footprint are simulated with actual BGA ball-out using the same PCB stackup
- Module CDR footprint is not included in the. Channel.



COM Code 3.1.0 Host-Module TP1a

□ Test case I/II (13, 31 mm) ASIC packages.

Table 93A-1 parameters				I/O control			Table 93A-3 parameters		
Parameter	Setting	Units	Information				Parameter	Setting	Units
f_b	53.125	GBd		DIAGNOSTICS	1	logical	package_tl_gamma0_a1_a2	[0 0.0009909 0.0002772]	
f_min	0.05	GHz		DISPLAY_WINDOW	1	logical	package_tl_tau	6.141E-03	ns/mm
Delta_f	0.01	GHz		CSV_REPORT	1	logical	package_Z_c	[87.5 87.5 ; 92.5 92.5]	Ohm
C_d	[1.2e-4 0]	nF	[TX RX]	RESULT_DIR	.\results\100GEL_C2M_host_{date}\		ICN & FOM_ILD parameters		
L_s	[0.12 0]	nH	[TX RX]	SAVE_FIGURES	0	logical	f_v	0.445	*Fb
C_b	[0.3e-4 0]	nF	[TX RX]	Port Order	[1 3 2 4]		f_f	0.445	GHz f_r specified in first column
z_p select	[1 2]		[test cases to run]	RUNTAG	C2M_eval_		f_n	0.445	GHz
z_p (TX)	[13 31; 1.8 1.8]	mm	[test cases]	COM_CONTRIBUTION	0	logical	f_2	40	GHz
z_p (NEXT)	[0 0 ; 0 0]	mm	[test cases]	Local Search	2		A_ft	0.600	V
z_p (FEXT)	[13 31; 1.8 1.8]	mm	[test cases]	Operational			A_nt	0.600	V
z_p (RX)	[0 0 ; 0 0]	mm	[test cases]	VEC Pass threshold	12	db			
C_p	[0.87e-4 0]	nF	[TX RX]	EH_min	10	mV			
R_0	50	Ohm		ERL Pass threshold	7.3	dB			
R_d	[50 50]	Ohm	[TX RX]	DER_0	0.00001				
A_v	0.415	V	vp/vf=.694	T_r	0.01	ns			
A_fe	0.415	V	vp/vf=.694	FORCE_TR	1	5			
A_ne	0.608	V		PMD_type	C2M				
L	4			BREAD_CRUMBS	0	logical			
M	32	Samp/UI		SAVE_CONFIG2MAT	1	logical			
samples_for_C2M	100	Samp/UI		PLOT_CM	1	logical			
T_O	50	mUI		TDR and ERL options					
AC_CM_RMS	[0, 0]	V	[test cases]	TDR	1	logical			
filter and Eq				ERL	1	logical			
f_r	0.75	*fb		ERL_ONLY	0	logical			
c(0)	0.54		min	TR_TDR	0.01	ns			
c(-1)	[-0.2:0.02:0]		[min:step:max]	N	800				
c(-2)	[0:0.02:0.1]		[min:step:max]	beta_x	0				
c(-3)	[0]		[min:step:max]	rho_x	0.618				
c(1)	[-0.1:0.02:0]		[min:step:max]	fixture delay time	[0 0.2e-9]	[port1 port2]			
N_b	4	UI		TDR_W_TXPKG	1				
b_max(1)	0.4		As/dffe1	N_bx	0	UI			
b_max(2..N_b)	[0.15 0.1 0.1]		As/dfe2..N_b	Tukey_Window	1				
b_min(1)	0.1		As/dffe1	Receiver testing					
b_min(2..N_b)	[0.1 - 0.15 - 0.05]		As/dfe2..N_b	RX_CALIBRATION	0	logical			
g_DC	[-13:1:-3]	dB	[min:step:max]	Sigma BBN step	5.00E-03	V			
f_z	12.58	GHz		Noise, jitter					
f_p1	20	GHz		sigma_RJ	0.01	UI			
f_p2	28	GHz		A_DD	0.02	UI			
g_DC_HP	[-3:0.5:1]		[min:step:max]	eta_0	4.10E-08	V^2/GHz			
f_HP_PZ	1.328125	GHz		SNR_TX	32.5	dB			
G_Qual	[-2 -9 ; -2 -12 ; -4 -12 ; -6 -13]	dB	ranges	R_LM	0.95				
G2_Qual	[0 -1 -2 -3]	dB	ranges						

COM Code 3.1.0 Module to Host TP4

❑ Test case I/II (4, 7 mm) CDR packages.

Table 93A-1 parameters			
Parameter	Setting	Units	Information
f_b	53.125	Gbd	
f_min	0.05	GHz	
Delta_f	0.01	GHz	
C_d	[1.0e-4 0]	nF	[TX RX]
L_s	[0.12 0]	nH	[TX RX]
C_b	[0.3e-4 0]	nF	[TX RX]
z_p select	[1 2]		[test cases to run]
z_p (TX)	[4 7; 0 0]	mm	[test cases]
z_p (NEXT)	[0 0; 0 0]	mm	[test cases]
z_p (FEXT)	[4 7; 0 0]	mm	[test cases]
z_p (RX)	[0 0; 0 0]	mm	[test cases]
C_p	[0.65e-4 0]	nF	[TX RX]
R_0	50	Ohm	
R_d	[50 50]	Ohm	[TX RX]
A_v	0.415	V	vp/vf=.694
A_fe	0.415	V	vp/vf=.694
A_ne	0.608	V	
L	4		
M	32	Samp/UI	
samples_for_C2M	100	Samp/UI	
T_O	50	mUI	
AC_CM_RMS	[0, 0]	V	[test cases]
filter and Eq			
f_r	0.75	*fb	
c(0)	0.72		min
c(-1)	-0.18		[min:step:max]
c(-2)	0.04		[min:step:max]
c(-3)	[0]		[min:step:max]
c(1)	0		[min:step:max]
N_b	4	UI	
b_max(1)	0.4		As/dffe1
b_max(2..N_b)	[0.15 0.15 0.1]		As/dfe2..N_b
b_min(1)	0.1		As/dffe1
b_min(2..N_b)	[-0.15 -0.15 -0.05]		As/dfe2..N_b
g_DC	[-13:1:-1]	dB	[min:step:max]
f_z	12.58	GHz	
f_p1	20	GHz	
f_p2	28	GHz	
g_DC_HP	[-3:0.5:1]		[min:step:max]
f_HP_PZ	1.328125	GHz	
G_Qual	[-1 -9; -1 -12; -4 -12; -5 -13]	dB	ranges
G2_Qual	[0 -1 -2 -3]	dB	ranges

I/O control		
DIAGNOSTICS	1	logical
DISPLAY_WINDOW	1	logical
CSV_REPORT	1	logical
RESULT_DIR	.\results\100GEL_C2M_host_{date}	
SAVE_FIGURES	0	logical
Port Order	[2 4 1 3]	
RUNTAG	C2M_eval_	
COM_CONTRIBUTION	0	logical
Local Search	2	
Operational		
VEC Pass threshold	9	db
EH_min	15	mV
ERL Pass threshold	7.3	dB
DER_0	0.00001	
T_r	0.0075	ns
FORCE_TR	1	5
PMD_type	C2M	
BREAD_CRUMBS	0	logical
SAVE_CONFIG2MAT	1	logical
PLOT_CM	1	logical
TDR and ERL options		
TDR	1	logical
ERL	1	logical
ERL_ONLY	0	logical
TR_TDR	0.01	ns
N	800	
beta_x	0	
rho_x	0.618	
fixture delay time	[0 0.2e-9]	[port1 port2]
TDR_W_TXPKG	1	
N_bx	0	UI
Tukey_Window	1	
Receiver testing		
RX_CALIBRATION	0	logical
Sigma BBN step	5.00E-03	V
Noise, jitter		
sigma_RJ	0.01	UI
A_DD	0.02	UI
eta_0	4.10E-08	V^2/GHz
SNR_TX	32.5	dB
R_LM	0.95	

Table 93A-3 parameters		
Parameter	Setting	Units
package_tl_gamma0_a1_a2	[0 0.0009909 0.0002772]	
package_tl_tau	6.141E-03	ns/mm
package_Z_c	[87.5 87.5; 92.5 92.5]	Ohm
ICN & FOM_ILD parameters		
f_v	0.594	*Fb
f_f	0.594	GHz f_r specified in first column
f_n	0.594	GHz
f_z	40	GHz
A_ft	0.600	V
A_nt	0.600	V
Table 92-12 parameters		
Parameter	Setting	
board_tl_gamma0_a1_a2	[0 0.000599 0.0001022]	
board_tl_tau	5.790E-03	ns/mm
board_Z_c	100	Ohm
z_bp (TX)	200	mm
z_bp (NEXT)	200	mm
z_bp (FEXT)	200	mm
z_bp (RX)	0	mm
Include PCB	0	logical

new
updated for D1.4

Floating Tap Control			
N_bg	0	0 1 2 or 3 groups	
N_bf	3	taps per group	
N_f	40	I span for floating taps	
bmaxg	0.2	DFE value for floating taps	
for TP4-->			
	[1.2e-4 0]	nF	[TX RX]
	[0.12 0]	nH	[TX RX]
	[0.3e-4 0]	nF	[TX RX]
	[1 2 3]		[test cases to run]
	[2 7 8]	mm	[test cases]
	[0 0 0]	mm	[test cases]
	[2 7 8]	mm	[test cases]
	[0 0 0]	mm	[test cases]
	[0 0.87e-4]	nF	[TX RX]

COM Analysis on Lim Channel 1 and 4 – ASIC to Module

- **Lim channels include BGA footprint, via, host stripline, via, QSFP-DD connector and module module PCB**
 - Results for test case l=13 mm is pathological and consistent when timing window $t_s=0$
 - VEO results with 50 mUI window are reduced by ~half and VEC increases by ~4 dB
- **VEO and VEC limits**
 - D1.3 window=0 mUI, VEO= 15 mV and VEC= 9 dB
 - D2.0 window +/- 50 mUI, VEO= 10 mV and VEC= 12 dB
- **VEO/VEC limits have become more difficult for host to pass with addition of timing window $t_s= +/- 50$ mUI**
 - The VEO/VEC were to suppose to be adjusted for +/- 50 mUI window and limits have shifted the specifications!

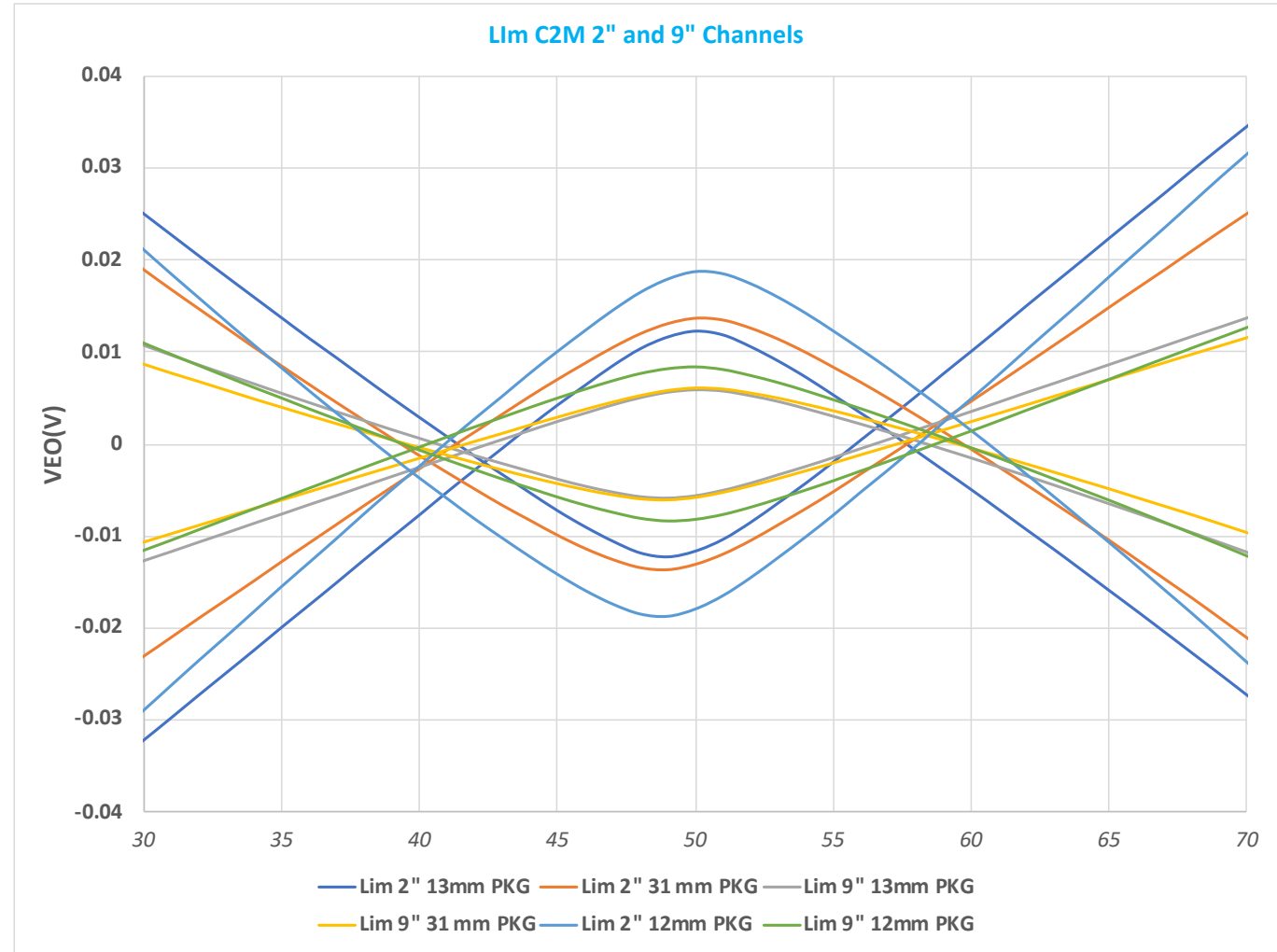
Channel	Window	Fitted IL@26.56 GHz	IL wPKG@26.55 GHz	VEO Case I/II/III 12/13/31 mm	VEC Case I/II/III 12/13/31 mm	EW Case I/II/III 12/13/31 mm	COM Case I/II/III* 12/13/31 mm
Lim Channel 2" at TP1a ILD = 0.084, ICN = 4.0 mV ERL[11,22]= [9.1, 9.1] dB	0	5.9 dB	11.3 dB	37.5/25.5/27.3	6.8/11.1/7.8	0.19/0.14/0.18	5.3/2.83/4.5
	+/- 50 mUI	5.9 dB	11.3 dB	26.2/13.3/18.7	9.9/16.4/11.1	0.19/0.14/0.18	3.3/1.4/2.8
Lim Channel 9" at TP1a ILD = 0.066, ICN = 1.7 mV ERL[11,22]=[10.9,11.4] dB	0	14.7 dB	20.3 dB	16.7/11.8/12.1	7.2/10/8.1	0.19/0.15/0.17	5.0/3.3/4.3
	+/- 50 mUI	14.7 dB	20.3 dB	11.3/7.1/7.9	10.6/14.4/11.8	0.19/0.15/0.17	1.8/2.6/3.0

* Per COM definition results with timing window $t_s=0$ is only applicable.

TP1a Eyes for 2" and 9" Lim Channels

□ The eye show the impact of sampling window on the VEO and associated VEC

- Given the eye shape there could be as much as 5 dB of VEC penalty due to +/- 50 mUI window
- The same eye with the window may have ½ the eye opening.



M2C Short and Long Channels

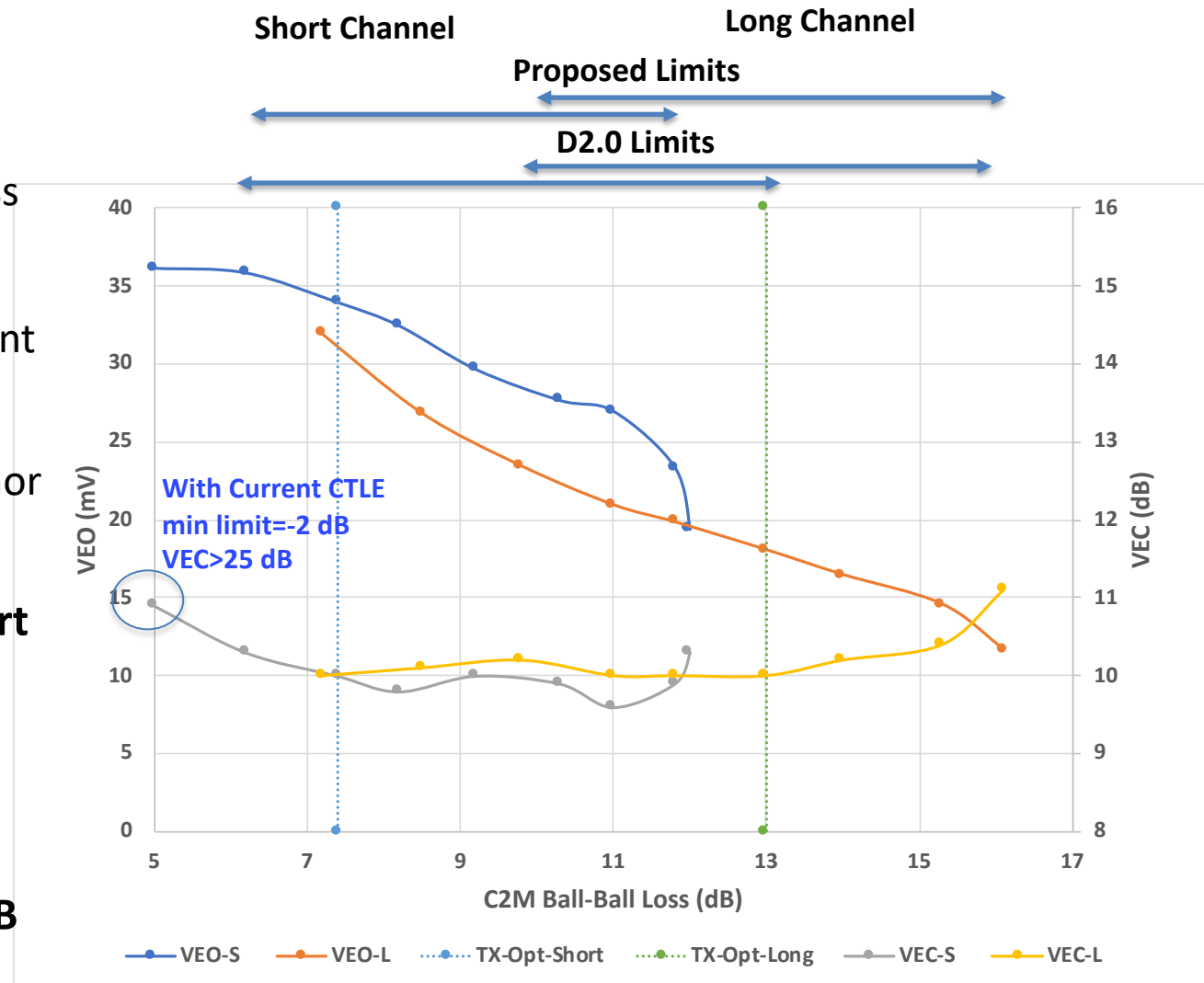
Current D2.0 definition of TP4 short and long

- Short 0 – 160 mm (6.6 dB) + MTF Loss
- Long 80 mm (3.1 dB) – 244.7 mm (9.6 dB) + MTF Loss
 - 9.6 dB + 6.6 dB MTF loss exceed max 16 dB
 - 244.7 mm should be reduced to 239.7 mm (9.4 dB)
- Short channel max loss up to 13.2 results in significant VEC/VEO degrading
 - Propose to reduce short channel max loss to 12 dB
- Not clear if MTF variations should be accounted or nor with current procedure explicitly specifying added trace

Proposed new limit for TP4 short/long adjusting short max loss and accounting for MTF loss

- Assumes MTF loss of 6.6 dB
 - Short range will be from 6.6 – 11.8 dB (0 – 132.6 mm)
 - Long range will be from 9.7 – 16 dB (80 – 239.7 mm)

If one allow short range to go to as low as 5 dB VEC > 25 dB but this issue is avoided if one adjust for 1.6 dB MTF loss difference otherwise gDC need to be reduced from -2 dB to -1 dB.



COM Analysis on Lim Channel 1a, 2a, 2b – Module to ASIC

□ Module to ASIC package results in less of impairments compare to ASIC to module

- In D2.0 VEO= 15 mV and VEC= 12 dB were added replacing TBD based on timing window of $t_s = \pm 50$ mUI
- D2.0 VEO and VEC are inline with results below and no change is necessary
- TP1a test point is equivalent to TP4 far end test point.

Channel	ILD, ICN, ERL	Fitted IL at 26.56 GHz (dB)	Total IL w PKG at 26.55 GHz (dB)	VEO mV Case I/II	EW UI Case I/II	VEC dB Case I/II	COM dB Case I/ II
Lim Channel 1a * TP4 near end	ILD = 0.1, ICN = 2.8 mV ERL11=10.9 dB, ERL22=10.7 dB	5.4	6.0	30/27	0.25/0.23	12.3/13	2.4/2.3
Lim Channel 2a * TP4 near end	ILD = 0.11, ICN = 4.9 mV ERL11=11.3 dB, ERL22=11.1 dB	5.9	6.7	24/21.6	0.19/0.20	13.7/14.6	2.0/1.8
Lim Channel 1a ** +200 mm TP4 far end	ILD = 0.1, ICN = 2.8 mV ERL11=10.9 dB, ERL22=10.7 dB	15.5	16.1	18.2/15.3	0.23/0.21	8.2/9.5	4.3/3.5
Lim Channel 2a ** +200 mm TP4 far end	ILD = 0.11, ICN = 4.9 mV ERL11=11.3 dB, ERL22=11.1 dB	16.1	16.8	16.2/13.8	0.22/0.22	8.9/10.1	3.9/3.2
Lim Channel 1b ** TP4 far end	ILD = 0.1, ICN = 2.1 mV ERL11=10.6 dB, ERL22=11.7 dB	14.8	15.8	16.0/11.1	0.21/0.18	9.5/12.8	3.5/2.3
Lim Channel 2b ** TP4 Far end	ILD = 0.12, ICN = 0.70 mV ERL11=11.7 dB, ERL22=10.3 dB	15.0	16.0	17.8/11.6	0.22/0.18	8.9/12.3	3.9/2.4

* TX FIR for short channel [0.02 -0.16 0.82 0]

** TX FIR for long channel [0.04 -0.18 0.78 0]

Summary

- ❑ **With introduction of timing window $t_s = \pm 50$ mUI the VEC=12 dB and VEO=10 mV at TP1a have been relax where it will result in large % of host channels failing**
 - The agreement was not to shift the specifications in favor of the module or the host
 - The intention was to just adjust VEC/VEO for the timing window $t_s = \pm 50$ mU
 - Lim host-module channel which are well constructed failing is concerning
- ❑ **The limits at TP4/TP4 far end with VEC=12 dB and VEO=15 mV are right on**
- ❑ **Given that ASIC-TP1a and CDR-TP4 are not symmetrical interfaces**
 - ASIC package has significantly greater amount impairment compare to CDR
 - Host channel also has greater amount of impairments compare to MCB and the synthetic channel
 - Then how is it possible that the standard has identical VEC at TP1a and TP4
- ❑ **Please adjust VEC and VEO to not penalize host and significantly drive their cost up**
 - Propose limits at TP1a are: VEO=8 mV and VEC=13.5 dB.